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RF SWITCH CG2214M6

L, S-band Medium Power SPDT Switch

DESCRIPTION

• The CG2214M6 is a pHEMT GaAs SPDT (<u>Single</u> <u>Pole</u> <u>Double</u> <u>Throw</u>) switch. This device can operate from 0.05 to 3.0 GHz, having low insertion loss and high isolation.

FEATURES

- Control voltage : VC(H) = 1.8 to 5.0 V (3.0 V TYP.) VC(L) = -0.2 to 0.2 V (0 V TYP.)
- High isolation : ISL1 = 38 dB TYP. @ f = 0.05 to 0.5 GHz ISL2 = 32 dB TYP. @ f = 0.5 to 1.0 GHz ISL3 = 27 dB TYP. @ f = 1.0 to 2.0 GHz ISL4 = 25 dB TYP. @ f = 2.0 to 2.5 GHz ISL5 = 23 dB TYP. @ f = 2.5 to 3.0 GHz
- Power handling : P_{in}(0.5dB) = +32 dBm TYP. @ f = 3.0 GHz VC(H) = 3.0 V, VC(L) = 0 V

ORDERING INFORMATION

PACKAGE

 6-pin lead-less mini mold package (1.5mm x 1.1mm x 0.55mm)

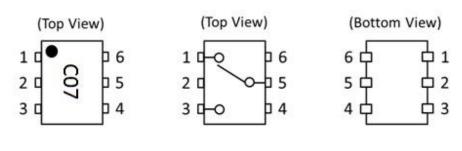


APPLICATIONS

- Wireless LAN (IEEE 802.11 b/g/n/ac)
- Bluetooth

| Part Number | Order Number | Package | Marking | Description |
|---------------|---------------|--|---------|--|
| CG2214M6 | CG2214M6-C2 | 6-pin lead-less mini mold package (Pb-Free) | C07 | Embossed tape 8 mm wide Pin 1, 6 face the perforation side of the tape MOQ 9 kpcs/reel |
| CG2214M6-EVAL | CG2214M6-EVAL | | | Evaluation Board with DC block capacitors, power supply bypass capacitors, and RF and DC connectors MOQ 1 |

PIN CONFIGURATION AND INTERNAL BLOCK DIAGRAM



| Pin No. | Pin Name |
|---------|----------|
| 1 | RF1 |
| 2 | GND |
| 3 | RF2 |
| 4 | VC2 |
| 5 | RFC |
| 6 | VC1 |

TRUTH TABLE

| VC1 | VC2 | RFC-RF1 | RFC-RF2 |
|------|------|---------|---------|
| Low | High | ON | OFF |
| High | Low | OFF | ON |

ABSOLUTE MAXIMUM RATINGS

(TA = +25°C, unless otherwise specified)

| Parameter | Symbol | Rating | Unit |
|-------------------------------|------------------|-----------------------|------|
| Control Voltage | VC | 6.0 ^{Note 1} | V |
| Input Power | P _{in} | +33 ^{Note 2} | dBm |
| Operating Ambient Temperature | T _A | -45 ~ +85 | °C |
| Storage Temperature | T _{stg} | -55 ~ +150 | °C |

Note 1. $|VC1 - VC2| \leq 6.0 V$

2. 3.0V \leq |VC1 – VC2| \leq 5.0 V, f \geq 0.5 GHz

RECOMMENDED OPERATING RANGE

| 1 | ΤΔ - | - +25°C | unlass | otherwise | specified | ١ |
|---|-------|----------|--------|-----------|-----------|---|
| | 1 ~ = | = +20 C, | uniess | otherwise | specified |) |

| Parameter | Symbol | MIN. | TYP. | MAX. | Unit |
|----------------------------|--------|------|------|------|------|
| Operating Frequency | f | 0.05 | - | 3.0 | GHz |
| Switch Control Voltage (H) | VC(H) | +1.8 | +3.0 | +5.0 | V |
| Switch Control Voltage (L) | VC(L) | -0.2 | 0 | +0.2 | V |

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ELECTRICAL CHARACTERISTICS

 $(TA = +25^{\circ}C, VC(H) = 3.0 V, VC(L) = 0 V, Zo = 50 \Omega, DC Block Capacitance = 56 pF, unless otherwise specified)$

| Parameter | Symbol | Condition | MIN. | TYP. | MAX. | Unit |
|---------------------------------------|------------------------|------------------------------------|------|------|------|------|
| Insertion Loss | L _{INS} 1 | f=0.05 to 0.5GHz ^{Note 1} | - | 0.30 | 0.50 | dB |
| | L _{INS} 2 | f=0.5 to 1.0GHz | - | 0.30 | 0.50 | dB |
| | L _{INS} 3 | f=1.0 to 2.0GHz | - | 0.30 | 0.50 | dB |
| | L _{INS} 4 | f=2.0 to 2.5GHz | - | 0.35 | 0.55 | dB |
| | L _{INS} 5 | f=2.5 to 3.0GHz | - | 0.35 | 0.55 | dB |
| Isolation | ISL1 | f=0.05 to 0.5GHz ^{Note 1} | 35 | 38 | - | dB |
| | ISL2 | f=0.5 to 1.0GHz | 29 | 32 | - | dB |
| | ISL3 | f=1.0 to 2.0GHz | 24 | 27 | - | dB |
| | ISL4 | f=2.0 to 2.5GHz | 22 | 25 | - | dB |
| | ISL5 | f=2.5 to 3.0GHz | 20 | 23 | - | dB |
| Return Loss | RL1 | f=0.05 to 0.5GHz ^{Note 1} | 15 | 20 | - | dB |
| | RL2 | f=0.5 to 3.0GHz | 15 | 20 | - | dB |
| 0.1dB Loss Compression Input Power | P _{in(0.1dB)} | f=3.0GHz, VC(H)=1.8V, VC(L)=0V | - | +23 | - | dBm |
| Note 2 | | f=3.0GHz, VC(H)=3.0V, VC(L)=0V | - | +30 | - | dBm |
| 0.5dB Loss Compression Input Power | P _{in(0.5dB)} | f=3.0GHz, VC(H)=1.8V, VC(L)=0V | - | +26 | - | dBm |
| Note 3 | | f=3.0GHz, VC(H)=3.0V, VC(L)=0V | - | +32 | - | dBm |
| 2nd Harmonics | 2f0 | f=3.0GHz, P _{in} =+20dBm | - | -85 | - | dBc |
| 3rd Harmonics | 3f0 | f=3.0GHz, P _{in} =+20dBm | - | -85 | - | dBc |
| 3rd Order Input Intercept Point | IIP ₃ | f=2.5GHz, 2-tone 1MHz Spacing | - | +58 | - | dBm |
| Switch Control Current | I _{CONT} | RF none | - | 1 | 10 | uA |
| Switching Speed | t _{sw} | 50% CTL to 90/10% RF | - | 50 | - | ns |

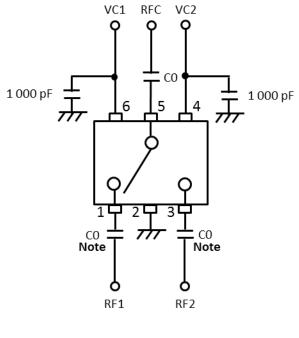
Note 1. DC block capacitance = 1000 pF at f = 0.05 to 0.5 GHz

2. P_{in(0.1dB)} is the measured input power level when the insertion loss increases 0.1dB more than that of the linear range.

3. P_{in(0.5dB)} is the measured input power level when the insertion loss increases 0.5dB more than that of the linear range

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EVALUATION CIRCUIT

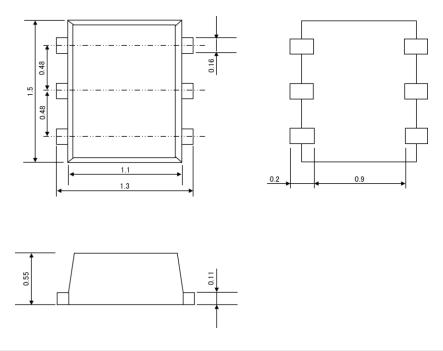


Note C0 : 0.05 to 0.5 GHz 1000pF : 0.5 to 3.0 GHz 56pF

The application circuits and their parameters are for reference only and are not intended for use in actual designs. DC Blocking Capacitors are required at all RF ports.

PACKAGE DIMENSIONS

6-pin lead-less mini mold package (Unit: mm)





RECOMMENDED SOLDERING CONDITIONS

Recommended Soldering Conditions are available on CEL's Part Summary page under Associated Documents



REVISION HISTORY

| Version | Change to current version | Page(s) |
|---|--|---------|
| CDS-0021-01 (Issue A) February 17, 2016 | Initial datasheet | N/A |
| CDS-0021-02 (Issue B) March 29, 2016 | Added Eval Board ordering information Updated marking information | 1, 2 |
| CDS-0021-03 (Issue C) April 20, 2016 | Updated Features section | 1 |
| CDS-0021-03 (Issue D) August 11, 2016 | Removed "preliminary" | All |
| CDS-0025-01 (Issue A) September 14, 2016 | Revise CDS No. CDS-0021-03 to CDS-0025-01 | N/A |
| CDS-0025-01 (Issue B) January 11, 2017 | Revised Electrical Characteristics table Added "Recommended Soldering Conditions" section | 3, 5 |



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